

RELIA	BILITY TEST	
	VIBRATION TEST	TO BE NO INTERFERENCE IN OPERATION AFTER VIBRATION 12Hz TO 50Hz FOR 1 MINUTE FULL AMPLITUDE, FOR 1.5 HOUR AT 3 AXISES.
	DROP TEST	TO BE NO INTERFERENCE IN OPERATION AFTER DROPPED TO CONCERTET FLOOR EACH ONE TIME FROM 1 METER HEIGHT AT 3 DIRECTONS IN STATE OF PACKING.
	TEMPERATURE TEST	<ul> <li>a) AFTER EXPOSURE AT 55° FOR 1 HOUR, SENSITIVITY TO BE WITHIN</li> <li>+/-3dB FROM INITIAL.</li> <li>b) AFTER EXPOSURE AT -10° FOR 1 HOUR, SENSITIVITY TO BE WITHIN</li> <li>+/-3dB FROM INITIAL.</li> <li>(THE MEASUREMENT TO BE DONE AFTER 2 HOURS OF CONDITIONING</li> <li>AT 25°C.)</li> </ul>
	HUMIDITY TEST	AFTER EXPOSURE AT 40°C AND 95% RH FOR 48 HOURS, SENSITIVITY TO BE WITHIN +/-3dB FROM INITIAL. (AFTER 1 HOUR OF CONDITIONING AT 25°C.)
	TEMPERATURE CYCLE TEST	AFTER EXPOSURE AT -10°C FOR 1HOUR, AT 25°C FOR 1 HOUR, AT 50°C FOR 1 HOUR, ATO 25°C FOR 2 HOURS, 4 CYCLES ,SENSITIVITY TO BE WITHIN +/-3dB. (AFTER 2 HOURS OF CONDITIONING AT 25°C)

## \*REGARDING THE SOLDERING OPERATION:

EACH CONDENSER MICROPHONE CONTAINS A FET WITHIN ITS CASE. GENERALLY, OVER-HEATING, OVER-CHARGE OF VOLTAGE IS EASY TO DESTROY SEMICONDUCTORS.

- 1. USE 30W (OR UNDER) SOLDERING IRON AND MAINTAIN 230°~260°C IN OPERATION.
- 2. SOLDERING SHOULD BE ACCOMPLISHED WITHIN TWO SECONDS AT EACH TERMINAL SO AS NOT TO BE OVERHEATED.
- 3. DO NOT MAKE A CAVITY AT THE SERFACE OF LEAD ON THE PATTERN PLATE. (A CAVITY MAY CHANGE THE CHARACTERISTICE OF CONDENSER MICROPHONE.)